

Harvatek Surface Mount LED Data Sheet HT-191IRAJ-XXXX

Official Product	Product: HT-191IRAJ-XXXX			Data Sheet No.
Tentative Product	*********	HT-191IRAJ-XXXX		
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DISCLAIMER

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- 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- 2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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Product Specifications

Product	Peak Wavelength	Test Current $I_{FP} (mA)$ $t_{P} = 20ms$	Radiant Intensity (mW/Sr)	Forward Voltage V _F (V)	Orderable Part Number
HT-191IRAJ	940 nm	100	1.0 min	1.25 typ	HT-191IRAJ-XXXX
	Specification		Material		Quantity
Resin	Water clear		Epoxy resin		
Carrier tape	Per EIA 481-1A spe	ecs	Transparent		4000 pcs per reel
Reel	Per EIA 481-1A spe	ecs	Plastic / White		
Label	HT standard		Paper		
Packing bag	220x240mm		Aluminum laminated bag/ no-zipper		One reel per bag
Carton	HT standard		Paper		

Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv, λ_D and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

Compliance and Certification

RoHS compliant and IS9002, QS9000 and ISO14001 certified.



ATTENTION: Electrostatic Discharge (ESD) protection



The symbol to the left denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AllnGaP, GaN, or/and InGaN

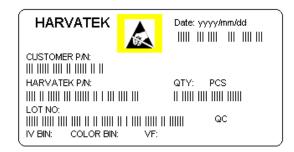
based chips are **STATIC SENSITIVE devices**. ESD precaution must be taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

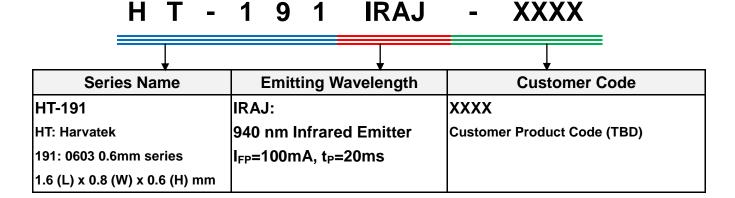
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Label Specifications



Harvatek P/N:



Lot P/N:

1 2 3 4 5 6 7 8 9 10 **P 1 2 2 3 0 A - D T**

Code 1	Code 2	Code 3	Code 4, 5	Code 6, 7	Code 9	Code 10
	Mfg. Year	Mfg. Month	Mfg. Date	Lots	Resin Color	Packaging
		1: Jan.				
	Z: 2000	2: Feb.				
Internal	1: 2001			04.00	C. Class	
Tracing	2: 2002	9: Sep.	1~31/ (30)	30) 01~99,	C: Clear	T: Tape & Reel
Code	3: 2003	A: Oct.		A,B,C	D: Diffused	
		B: Nov.				
		C: Dec.				

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Product Features

Absolute Maximum Rating

Parameter	Symbol	Max.	Unit
Power Dissipation	P_D	80	mW
Continuous Forward Current	I _F	50	mA
Reverse Voltage	V_R	5	V
Operating Temperature	T _{OP}	-30 to 80	°C
Storage Temperature	T _{ST}	-40 to 85	°C

* @ t_P = 10 μs, duty cycle = 1%

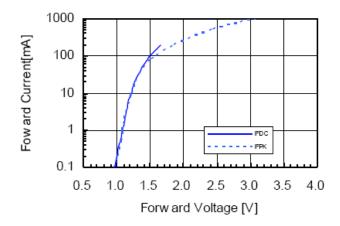
Package Outline Dimension Recommended Soldering Pattern for Reflow Soldering Unit: mm Tolerance: +/-0.1 **Outline Dimension** Solder Pattern Mark-(0.6)1.0 LED Die-4.0 Polarity 0.8 0.7 0.8 Resin Cathode side Soldering terminals may shift in the x, y direction. Unit: mm

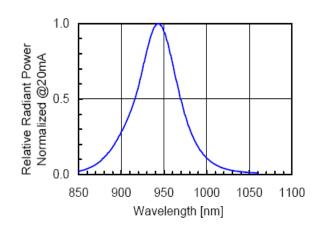
Electro-Optical Characteristics							
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition	
Forward Voltage	V_{F}	ı	1.25	1.6	V	I _F =20mA	
Reverse Current	I _R	-	-	10	uA	V _R =5V	
Peak Emission Wavelength	λ_{P}	ı	940	-	nm	I _F =20mA	
Radiant Intensity		1.0	2.5		mW/sr	I _{FP} =100mA	
Radiant intensity	l _e	1.0	2.5	_	11100/51	t _P =20ms	
Spectral Wavelength	Δλ	1	50	_	nm	I _F =20mA	
Emission Angle	2½θ	-	140	_	degrees	_	

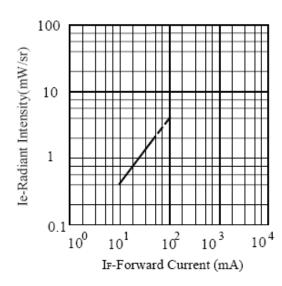
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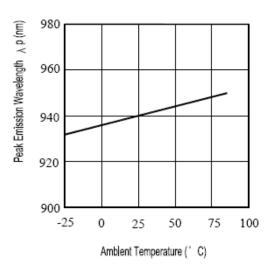


Characteristics Curves

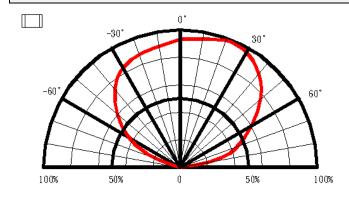


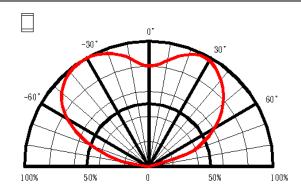






Radiation Pattern



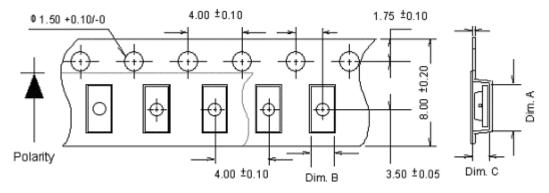


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Packaging

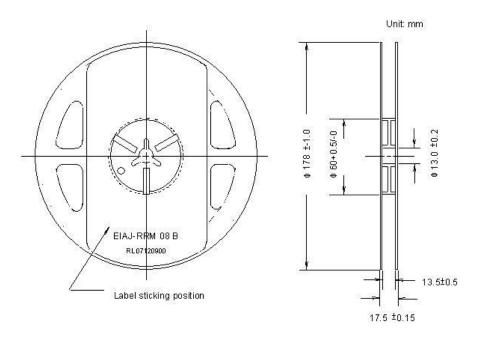
Tape Dimension



Part No.	Dim. A	Dim. B	Dim. C	Q'ty/Reel
HT-191IRA-XXXX	1.80±0.10	0.95±0.10	0.75±0.10	4K

Unit: mm

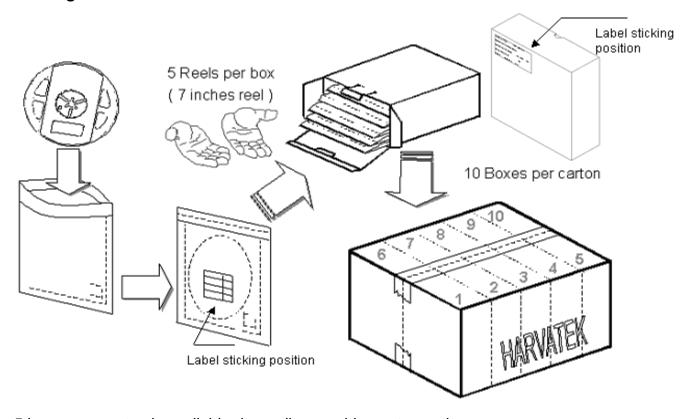
Reel Dimension



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Packing



5 boxes per carton is available depending on shipment quantity.

	Specification	Material	Quantity
Carrier tape	Per EIA 481-1A specs	Transparent	4000 pcs per reel
Reel	Per EIA 481-1A specs	Plastic / White	
Label	HT standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	HT standard	Paper	Non-specified

Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv, λ_D and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

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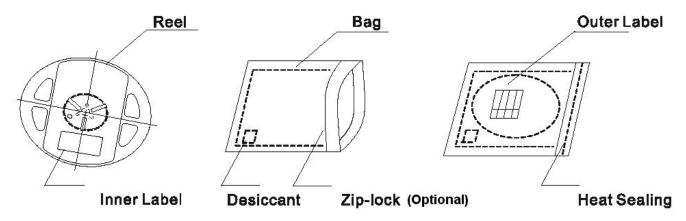


Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

The packaging sequence is as follows:



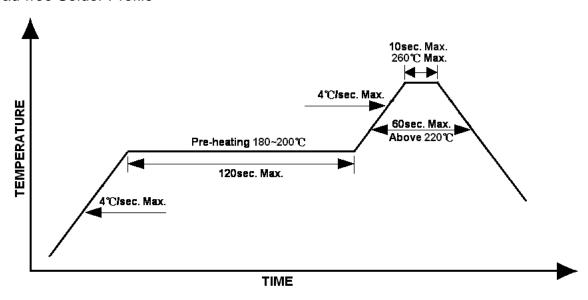
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Reflow Soldering

- Recommended tin glue specifications: melting temperature in the range of 178~192 °C
- The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):

Lead-free Solder Profile



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Precautions

- 1. Avoid exposure to moisture at all times during transportation or storage.
- 2. Anti-Static precaution must be taken when handling GaN, InGaN, and AllnGaP products.
- 3. It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage beyond the specified limit.
- 4. Avoid operation beyond the limits as specified by the absolute maximum ratings.
- 5. Avoid direct contact with the surface through which the LED emits light.
- 6. If possible, assemble the unit in a clean room or dust-free environment.

Reworking

- Rework should be completed within 5 seconds under 191 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min

Cautions of Pick and Place

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electro-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.

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Revision History

Changes since last revision	Page	Version No.	Revision Date
Initial Release – XXXX		1.0	08-20-2009

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